

# Місвоснір dsPIC30F6011/6012/6013/6014

# dsPIC30F6011/6012/6013/6014 Family Silicon Errata and Data Sheet Clarification

The dsPIC30F6011/6012/6013/6014 family devices that you have received conform functionally to the current Device Data Sheet (DS70117F), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.

The errata described in this document will be addressed in future revisions of the dsPIC30F6011/6012/6013/6014 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision (B2).

Data Sheet clarifications and corrections start on page 25, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB<sup>®</sup> IDE and Microchip's programmers, debuggers and emulation tools, which are available at the Microchip corporate web site (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with MPLAB ICD 2 or PICkit<sup>™</sup> 3:

- Using the appropriate interface, connect the device to the MPLAB ICD 2 programmer/debugger or PICkit 3.
- From the main menu in MPLAB IDE, select <u>Configure>Select Device</u>, and then select the target part number in the dialog box.
- Select the MPLAB hardware tool (*Debugger*>Select Tool).
- Perform a "Connect" operation to the device (<u>Debugger>Connect</u>). Depending on the development tool used, the part number and Device Revision ID value appear in the **Output** window.

**Note:** If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The Device and Revision ID values for the various dsPIC30F6011/6012/6013/6014 silicon revisions are shown in Table 1.

TABLE 1: SILICON DEVREY VALUES

Part Number	Device ID <sup>(1)</sup>	Revision ID for Silicon Revision <sup>(2)</sup>			
Part Number	Device ID.	А3	B1	B2	
dsPIC30F6011	0x0192				
dsPIC30F6012	0x0193	0x1003	0x1040	0x1042	
dsPIC30F6013	0x0197	0000	0X1040		
dsPIC30F6014	0x0198				

- **Note 1:** The Device and Revision IDs (DEVID and DEVREV) are located at the last two implemented addresses in program memory.
  - 2: Refer to the "dsPIC30F Flash Programming Specification" (DS70102) for detailed information on Device and Revision IDs for your specific device.

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Issue Summary		Affected Revisions <sup>(1)</sup>		
		Number		А3	B1	B2	
Data EEPROM	Speed	1.	Data EEPROM is operational at 20 MIPS.	Х	Х	Х	
CPU	Unsigned  MAC Instruction	2.	The Unsigned Integer mode for the MAC-type DSP instructions does not function as specified.	Х	Х	X	
CPU	MAC class Instructions with ±4 Address Modification	3.	equential MAC instructions, which prefetch data from Y data pace using ±4 address modification, will cause an address pace trap.		X	X	
CPU	DAW.b Instruction	4.	The Decimal Adjust instruction, DAW.b, may improperly clear the Carry bit, C (SR<0>).	Х	Х	Х	
PSV Operations		5.	In certain instructions, fetching one of the operands from program memory using Program Space Visibility (PSV) will corrupt specific bits in the STATUS Register, SR.	Х	Х	X	
CPU	Nested DO Loops	6.	When using two DO loops in a nested fashion, terminating the inner-level DO loop by setting the EDT bit (CORCON<11>) will produce unexpected results.	Х	Х	Х	
Flash Memory	RTSP	7.	When a device Reset occurs while an Run-Time Self- Programming (RTSP) operation is ongoing, code execution may lead into an address error trap.		Х	Х	
Data Memory	Y Data Space	8.	When an instruction that writes to a location in the address range of Y data memory is immediately followed by a MAC-type DSP instruction that reads a location also resident in Y data memory, the operations will not be performed as specified.	Х	Х	Х	
Interrupt Controller	Traps	9.	When a catastrophic overflow of any of the accumulators causes an arithmetic (math) error trap, the Overflow Status bits need to be cleared to exit the trap handler.	Х	Х	Х	
CPU	REPEAT Instruction	10.	When a REPEAT loop is interrupted by two or more interrupts in a nested fashion, an address error trap may be caused.	Х	Х	Х	
CPU	DISI Instruction	11.	The DISI instruction will not disable interrupts if a DISI instruction is executed in the same instruction cycle that the DISI counter decrements to zero.	Х	Х	Х	
Timers	32-bit Mode	12.	The 32-bit general purpose timers do not function as specified for prescaler ratios other than 1:1.	Х	Х	Х	
Output Compare	_	13.	The Output Compare module will produce a glitch on the output when an I/O pin is initially set high, and the module is configured to drive the pin low at a specified time.	Х	Х	Х	
ADC	Channel Scanning	14.	The 12-bit ADC scans one channel less than that specified when configured to perform channel scanning on MUX A inputs and alternately converting a fixed MUX B input.	Х	Х	Х	
DCI	Slave Mode	15.	In Slave mode, the DCI module does not function correctly when data communication is configured to start one serial clock after the frame synchronization pulse.			Х	
DCI	Idle Mode	16.	The DCI module should not be stopped when the device enters Idle mode.	Х	Х	Х	

Note 1: Only those issues indicated in the last column apply to the current silicon revision.

TABLE 2: SILICON ISSUE SUMMARY (CONTINUED)

Module	Feature	Item Number	Issue Summary		ffecto	
		Number	-	А3	B1	B2
CAN	Read Operations on SFRs	17.	Read operations performed on CAN module Special Function Registers (SFRs) may yield incorrect results at operation over 20 MIPS.	Х	Х	Х
Flash Memory	IDD Current	18.	This release of silicon exhibits a current draw (IDD) of approximately 370 mA during a Row Erase operation performed on program Flash memory.	Х	Х	Х
CPU	Voltage Regulation	19.	For this release of silicon, applications operating off 5 volts VDD at 30 MIPS should ensure that the VDD remains within 5% of 5 volts.	Х	Х	Х
Flash Memory	Code Protection	20.	Addresses in the range 0x6000 through 0xFFFF may not be code-protected for this revision of dsPIC30F6011 and dsPIC30F6013 silicon.	X	X	Х
PLL	4x Mode	21.	The 4x PLL mode of operation may not function correctly for certain input frequencies.	Х	Х	Х
Interrupt Controller	_	22.	An interrupt occurring immediately after modifying the CPU IPL, interrupt IPL, interrupt enable or interrupt flag may cause an address error trap.	Х	Х	Х
PLL	8x Mode	23.	If 8x PLL mode is used, the input frequency range is 5 MHz-10 MHz instead of 4 MHz-10 MHz.	Х	Х	Х
Sleep Mode	_	24.	Execution of the Sleep instruction (PWRSAV #0) may cause incorrect program operation after the device wakes up from Sleep. The current consumption during Sleep may also increase beyond the specifications listed in the device data sheet.		Х	Х
I <sup>2</sup> C™	Slave Mode	25.	The $I^2C$ module loses incoming data bytes when operating as an $I^2C$ slave.	Х	Х	Х
I/O	Port Pin Multiplexed with IC1	26.	The port I/O pin multiplexed with the Input Capture 1 (IC1) function cannot be used as a digital input pin when the UART auto-baud feature is enabled.	Х	Х	Х
I <sup>2</sup> C	10-bit Addressing	27.	When the I <sup>2</sup> C module is configured for 10-bit addressing using the same address bits (A10 and A9) as other I <sup>2</sup> C devices, the A10 and A9 bits may not work as expected.	X	Х	X
Timer	Sleep Mode	28.	Clock switching prevents the device from waking up from Sleep.	Χ	Χ	Χ
PLL	Lock Status bit	29.	The PLL LOCK Status bit (OSCCON<5>) can occasionally get cleared and generate an oscillator failure trap even when the PLL is still locked and functioning correctly.	X	X	X
PSV Operations	_	30.	An address error trap occurs in certain addressing modes when accessing the first four bytes of any PSV page.	Х	Х	Х
I <sup>2</sup> C	10-bit Addressing	31.	The 10-bit slave does not set the RBF flag or load the I2CxRCV register, on address match if the Least Significant bits (LSbs) of the address are the same as the 7-bit reserved addresses.		Х	Х
I <sup>2</sup> C	10-bit Addressing	32.	When the I <sup>2</sup> C module is configured as a 10-bit slave with an address of 0x102, the I2CxRCV register content for the lower address byte is 0x01 rather than 0x02.			Х
I <sup>2</sup> C	Bus Collision	33.	When the I <sup>2</sup> C module is enabled, the dsPIC <sup>®</sup> DSC device generates a glitch on the SDA and SCL pins, causing a false communication start in a single-master configuration or a bus collision in a multi-master configuration.			Х
CAN	RX Filters 3, 4 and 5	34.	CAN Receive filters 3, 4 and 5 may not work for a given combination of instruction cycle speed and CAN bit time quanta.	Х	Х	Х

**Note 1:** Only those issues indicated in the last column apply to the current silicon revision.

# dsPIC30F6011/6012/6013/6014

TABLE 2: SILICON ISSUE SUMMARY (CONTINUED)

Module Feature		Item Number	Issue Summary		Affected Revisions <sup>(1</sup>		
		Number		А3	В1	B2	
Interrupt Controller	IPC2 Write Sequence	35.	A specific write sequence for Interrupt Priority Control 2 (IPC2) SFR is required.	Х	Х		
Program Memory	RTSP Operations	36.	RTSP operations may not be performed on the Program Memory. RTSP operations can however be performed on the on-chip Data EEPROM.	Х			
ADC	Sequential Sampling	37.	Sampling multiple channels sequentially using any conversion trigger other than the auto-convert feature requires SAMC bits to be non-zero.	Х			
QEI	Index Pulse Mode	38.	The Reset on Index Pulse Mode does not work.	Х			
PWM	Time Base Prescalers	39.	The Motor Control PWM Time base prescaler options: 1:4, 1:16 and 1:64 may produce unexpected results when used to generate center-aligned PWM pulses.	Х			
PWM	Output Override	40.	The output override function of the PWM module, controlled by the OVDCON register and the OSYNC bit (PWMCON2<1>), produces unexpected results in certain cases when the module is used in Complementary mode.	Х			
CPU	IPD Sleep Current	41.	The device exhibits IPD less than 0.1 $\mu$ A. However, certain work arounds are required to achieve IPD in this range.	Х			
ADC	Current Consumption in Sleep Mode	42.	If the ADC module is in an enabled state when the device enters Sleep Mode, the power-down current (IPD) of the device may exceed the device data sheet specifications.	Х	Х	Х	

**Note 1:** Only those issues indicated in the last column apply to the current silicon revision.

# Silicon Errata Issues

Note:

This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**B2**).

#### 1. Module: Data EEPROM

At device throughput greater than 20 MIPS for VDD, in the range 4.75V to 5.5V (or 10 MIPS for VDD in the range 3V to 3.6V), Table Read instructions (TBLRDL/TBLRDH) and instructions that use Program Space Visibility do not function correctly when reading data from data EEPROM.

#### Work around

When reading data from data EEPROM, the application should perform a clock switch operation to lower the frequency of the system clock so that the throughput is less than 20 MIPS. This may be easily performed at any time via the Oscillator Postscaler bits, POST<1:0> (OSCCON<7:6>), that allow the application to divide the system clock down by a factor of 4, 16 or 64.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ	Χ	Χ			

#### 2. Module: CPU

The US bit (CORCON<12>) controls whether MACtype DSP instructions operate in Signed or Unsigned mode. The device defaults to a Signed mode on power-up (US = 0).

For this revision of silicon, MAC-type DSP instructions do not function as specified in Unsigned mode (US = 1). Also, for this revision, the US bit will always read as  $^{\circ}$ 0'.

# Work around

Ensure that the US bit is not set by the application. In order to perform unsigned integer multiplications, use the MCU Multiply instruction, MUL. UU.

#### Affected Silicon Revisions

А3	B1	B2			
Χ	Х	Х			

#### 3. Module: CPU

Sequential MAC class instructions, which prefetch data from Y data space using  $\pm 4$  address modification, will cause an address error trap. The trap occurs only when all of the following conditions are true:

- Two sequential MAC class instructions (or a MAC class instruction executed in a REPEAT or DO loop) that prefetch from Y data space.
- 2. Both instructions prefetch data from Y data space using the + = 4 or = 4 address modification.
- Neither of the instruction uses an accumulator write back.

#### Work around

The problem described above can be avoided by using any of the following methods:

- 1. Inserting any other instruction between the two MAC class instructions.
- Adding an accumulator write back (a dummy write back if needed) to either of the MAC class instructions.
- 3. Do not use the + = 4 or = 4 address modification.
- 4. Do not prefetch data from Y data space.

А3	B1	B2			
Χ	Χ	Χ			

# dsPIC30F6011/6012/6013/6014

# 4. Module: CPU

The Decimal Adjust instruction, DAW.b, may improperly clear the Carry bit, C (SR<0>), when executed.

# Work around

Check the state of the Carry bit prior to executing the  $\mathtt{DAW.b}$  instruction. If the Carry bit is set, set the Carry bit again after executing the  $\mathtt{DAW.b}$  instruction. Example 1 shows how the application should process the Carry bit during a BCD addition operation.

# EXAMPLE 1: CHECK CARRY BIT BEFORE DAW.b

```
.include "p30fxxxx.inc"
......

mov.b #0x80, w0 ;First BCD number
mov.b #0x80, w1 ;Second BCD number
add.b w0, w1, w2 ;Perform addition
bra NC, L0 ;If C set go to L0
daw.b w2 ;If not, do DAW and
bset.b SR, #C ;set the carry bit
bra L1 ;and exit
L0:daw.b w2
L1: ....
```

A	3	B1	B2			
)	<	Χ	Χ			

# 5. Module: PSV Operations

When one of the operands of instructions shown in Table 3 is fetched from program memory using Program Space Visibility (PSV), the STATUS Register, SR and/or the results may be corrupted.

These instructions are identified in Table 3. Example 2 demonstrates a scenario where this occurs.

Also, always use Work around 2 if the C compiler is used to generate code for dsPIC30F6011/6012/6013/6014 devices.

TABLE 3: AFFECTED INSTRUCTIONS

Instruction <sup>(1)</sup>	Examples of Incorrect Operation <sup>(2)</sup>	Data Corruption IN
ADDC	ADDC W0, [W1++], W2;	SR<1:0> bits <sup>(3)</sup> , Result in W2
SUBB	SUBB.b W0, [++W1], W3;	SR<1:0> bits <sup>(3)</sup> , Result in W3
SUBBR	SUBBR.b W0, [++W1], W3;	SR<1:0> bits <sup>(3)</sup> , Result in W3
СРВ	CPB W0, [W1++], W4;	SR<1:0> bits <sup>(3)</sup>
RLC	RLC [W1], W4 ;	SR<1:0> bits <sup>(3)</sup> , Result in W4
RRC	RRC [W1], W2 ;	SR<1:0> bits <sup>(3)</sup> , Result in W2
ADD (Accumulator-based)	ADD [W1++], A ;	SR<1:0> bits <sup>(3)</sup>
LAC	LAC [W1], A ;	SR<15:10> bits <sup>(4)</sup>

- Note 1: Refer to the "dsPIC30F/33F Programmer's Reference Manual", (DS70157), for details on the dsPIC30F Instruction set.
  - 2: The errata only affects these instructions when a PSV access is performed to fetch one of the source operands in the instruction. A PSV access is performed when the Effective Address of the source operand is greater than 0x8000 and the PSV bit (CORCON<2>) is set to '1'. In the examples shown, the data access from program memory is made via the W1 register.
  - 3: SR<1:0> bits represent Sticky Zero and Carry Status bits respectively.
  - 4: SR<15:10> bits represent Accumulator Overflow and Saturation Status bits.

# **EXAMPLE 2: INCORRECT RESULTS**

.includ	de "p30fxxxx.inc"
MOV.B MOV.B BSET	WREG, PSVPAG
MOV	#0x8200, W1;Set up W1 for ;indirect PSV access ;from 0x000200
ADD	W3, [W1++], W5 ;This instruction ;works ok
ADDC	W4, [W1++], W6 ;Carry flag and ;W6 gets ;corrupted here!

# **Work arounds**

# Work around 1: For Assembly Language Source Code

To work around the erratum in the MPLAB ASM30 assembler, the application may perform a PSV access to move the source operand from program memory to RAM or a W register prior to performing the operations listed in Table 3. The work around for Example 2 is demonstrated in Example 3.

# **EXAMPLE 3: CORRECT RESULTS**

.includ	de "p30fxxxx.inc"
	,
MOV.B	#0x00, w0 ;Load PSVPAG register
MOV.B	WREG, PSVPAG
BSET	CORCON, #PSV; Enable PSV
MOV	#0x8200, W1;Set up W1 for
	;indirect PSV access
	;from 0x000200
ADD	W3, [W1++], W5; This instruction
	;works ok
MOV	[W1++], W2 ;Load W2 with data
1·10 V	
	;from program memory
ADDC	W4, W2, W6 ; Carry flag and W4
	results are ok!

# Work around 2: For C Language Source Code

For applications using C language, MPLAB C30 versions 1.20.04 or higher provide the following command-line switch that implements a work around for the erratum.

-merrata=psv

Refer to the "readme.txt" file in the MPLAB C30 v1.20.04 toolsuite for further details.

А3	B1	B2			
Χ	Х	Х			

# 6. Module: CPU

When using two DO loops in a nested fashion, terminating the inner-level DO loop by setting the EDT bit (CORCON<11>) will produce unexpected results. Specifically, the device may continue executing code within the outer DO loop forever. This erratum does not affect the operation of the MPLAB C30 compiler.

# Work around

The application should save the DCOUNT Special Function Register (SFR) prior to entering the inner DO loop and restore it upon exiting the inner DO loop. This work around is shown in Example 4.

# EXAMPLE 4: SAVE AND RESTORE DCOUNT

		DOCONT	
	.includ	de "p30fxxxx	.inc"
	DO #CNT		;Outer loop start
	PUSH DO		;Save DCOUNT
			;starts
	BTSS	Flag, #0	
	BSET	CORCON, #EI	OT;Terminate inner
			;DO-loop early
LOOP1:	MOV POP		;Inner loop ends ;Restore DCOUNT
LOOP0:		W5, W8	;Outer loop ends
Note:	EDT bit	, see secti dsPIC30F Fa	functionality of on 2.9.2.4 mily Reference

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ	Χ	Χ			

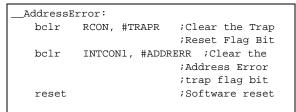
# 7. Module: Flash Memory

If a device Reset occurs while an Run-Time Self-Programming (RTSP) operation is ongoing, code execution after the Reset may lead to an address error trap.

# Work around

The user should define an address error Trap Service Routine (TSR), as shown in Example 5, in order to allow normal code execution to continue.

# **EXAMPLE 5: TRAP SERVICE ROUTINE**



А3	B1	B2			
Χ	Χ	Χ			

#### 8. Module: Data Memory

When an instruction that writes to a location in the address range of Y data memory (addresses between 0x1800 and 0x27FF) is immediately followed by a MAC-type DSP instruction that reads a location also resident in Y data memory, the two operations will not be executed as specified. This is demonstrated in Example 6.

# **EXAMPLE 6: INCORRECT RESULTS**

MOV	#0x190A, W0	;Load address > = ;0x1800 into W0
MOV	#0x19B0, W10	;Load address >=
MOV	W2, [W0++]	;0x1800 into W10 ;Perform indirect
1-10 V	WZ, [WOII]	;write via W0 to
		;address >= 0x1800
MAC	W4*W5, A, [W10]	+=2, W5 ;Perform
		read operation;
		;using Y-AGU
:Unexpected	l Results!	

#### **Work arounds**

#### Work around 1:

Insert a NOP between the two instructions as shown in Example 7.

#### **EXAMPLE 7: CORRECT RESULTS**

MOV	#0x190A, W0	;Load address > =
		;0x1800 into W0
MOV	#0x19B0, W10	;Load address >=
		;0x1800 into W10
MOV	W2, [W0++]	;Perform indirect
		;write via W0 to
		<pre>;address &gt;= 0x1800</pre>
NOP		;No operation
MAC	W4*W5, A, [W10	)]+=2, W5 ;Perform
		read operation;
		using Y-AGU;
:Correct	Results!	

# Work around 2:

If work around #1 is not feasible due to application real-time constraints, the user may take precautions to ensure that a write operation performed on a location in Y data memory is not immediately followed by a DSP MAC-type instruction that performs a read operation of a location in Y data memory.

# **Affected Silicon Revisions**

А3	B1	B2			
Χ	Χ	Χ			

#### 9. Module: Interrupt Controller

Catastrophic accumulator overflow traps are enabled as follows:

- COVTE (INTCON1<8>) = 1
- SATA/SATB (CORCON <7:6>) = 0

A carry generated out of bit 39 in the accumulator causes a catastrophic overflow of the accumulator since the sign bit has been destroyed. If a math error trap handler has been defined, the processor will vector to the math error trap handler upon a catastrophic overflow.

If the respective Accumulator Overflow status bit, OA or OB (SR<15/14>), is not cleared within the trap handler routine prior to exiting the trap handler routine, the processor will immediately re-enter the trap handler routine.

#### Work around

If a math error trap occurs due to a catastrophic accumulator overflow, the overflow status flags, OA and/or OB (SR<15:14>), should be cleared within the trap handler routine. Subsequently, the MATHERR (INTCON1<4>) flag bit should be cleared within the trap handler prior to executing the RETFIE instruction.

Since the OA and OB bits are read-only bits, it will be necessary to execute a dummy accumulator-based instruction within the trap service routine in order to clear these status bits, and eventually clear the MATHERR trap flag. This is shown in Example 8.

# EXAMPLE 8: USING DUMMY DSP INSTRUCTION

.globalI	MathErro	r	
MathError:	BTSC	SR, #OA	
	CLR	A	
	BTSC	SR, #OB	
	CLR	В	
	BCLR	INTCON1,	#MATHERR
	RETFIE		

А3	B1	B2			
Χ	Χ	Χ			

#### 10. Module: CPU

When interrupt nesting is enabled (or NSTDIS bit (INTCON1<15>) is '0'), the following sequence of events will lead to an address error trap:

- 1. REPEAT loop is active.
- 2. An interrupt is generated during the execution of the REPEAT loop.
- The CPU executes the Interrupt Service Routine (ISR) of the source causing the interrupt.
- Within the ISR, when the CPU is executing the first instruction cycle of the 3-cycle RETFIE (Return-from-Interrupt) instruction, a second interrupt is generated by a source with a higher interrupt priority.

# Work around

Processing of Interrupt Service Routines should be disabled while the RETFIE instruction is being executed. This may be accomplished in two different ways:

1. Place a DISI instruction immediately before the RETFIE instruction in all Interrupt Service Routines of interrupt sources that may be interrupted by other higher priority interrupt sources (with priority levels 1 through 6). This is shown in Example 9 in the Timer1 ISR. In this example, a DISI instruction inhibits level 1 through level 6 interrupts for 2 instruction cycles, while the RETFIE instruction is executed.

# **EXAMPLE 9:** DISI BEFORE RETFIE

```
__TlInterrupt: ;Timerl ISR

PUSH W0 ;This line optional
.....

BCLR IFS0, #TlIF

POP W0 ;This line optional

DISI #1

RETFIE ;Another interrupt occurs
;here and it is processed
;correctly
```

Immediately prior to executing the RETFIE instruction, increase the CPU priority level by modifying the IPL<2:0> bits (SR<7:5>) to '111' as shown in Example 10. This will disable all interrupts between priority levels 1 through 7.

# **EXAMPLE 10:** RAISE IPL BEFORE RETFIE

```
__T1Interrupt: ;Timer1 ISR

PUSH W0
......

BCLR IFS0, #T1IF
MOV.B #0xE0, W0
MOV.B WREG, SR
POP W0
RETFIE ;Another interrupt occurs
;here and it is processed
;correctly
```

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ	Х	Х			

#### 11. Module: CPU

When a user executes a DISI #7, for example, this will disable interrupts for 7 + 1 cycles (7 + the DISI instruction itself). In this case, the DISI instruction uses a counter which counts down from 7 to 0. The counter is loaded with 7 at the end of the DISI instruction.

If the user code executes another DISI on the instruction cycle where the DISI counter has become zero, the new DISI count is loaded, but the DISI state machine does not properly re-engage and continue to disable interrupts. At this point, all interrupts are enabled. The next time the user code executes a DISI instruction, the feature will act normally and block interrupts.

In summary, it is only when a DISI execution is coincident with the current DISI count = 0, that the issue occurs. Executing a DISI instruction before the DISI counter reaches zero will not produce this error. In this case, the DISI counter is loaded with the new value, and interrupts remain disabled until the counter becomes zero.

#### Work around

When executing multiple DISI instructions within the source code, make sure that subsequent DISI instructions have at least one instruction cycle between the time that the DISI counter decrements to zero and the next DISI instruction. Alternatively, make sure that subsequent DISI instructions are called before the DISI counter decrements to zero.

А3	B1	B2			
Х	Х	Х			

#### 12. Module: Timers

Pairs of 16-bit timers may be combined to form 32-bit timers. For example, Timer2 and Timer3 are combined into a single 32-bit timer. For this release of silicon, when a 32-bit timer is prescaled by ratios other than 1:1, unexpected results may occur.

# Work around

None. The application may only use the 1:1 prescaler for 32-bit timers.

# **Affected Silicon Revisions**

А3	B1	B2			
Χ	Х	Х			

# 13. Module: Output Compare

A glitch will be produced on an output compare pin under the following conditions:

- The user software initially drives the I/O pin high using the Output Compare module or a write to the associated PORT register.
- The Output Compare module is configured and enabled to drive the pin low at some point in later time (OCxCON = 0x0002 or OCxCON = 0x0003).

When these events occur, the Output Compare module will drive the pin low for one instruction cycle (TcY) after the module is enabled.

#### Work around

None. However, the user may use a timer interrupt and write to the associated PORT register to control the pin manually.

# Affected Silicon Revisions

А3	B1	B2			
Χ	Χ	Χ			

#### 14. Module: ADC

Input channel scanning allows the ADC to acquire and convert signals on a selected set of "MUX A" input pins in sequence. This function is controlled by the CSCNA bit (ADCON2<10>) and the ADCSSL SFR.

The ALTS bit (ADCON2<0>), when set, allows the ADC to alternately acquire and convert a "MUX A" input signal and a "MUX B" input signal in an interleaved fashion.

When both CSCNA and ALTS are set, the ADC module should scan MUX A input pins while alternating with a fixed MUX B input pin. However, for this release of silicon, when both features are enabled simultaneously, the last input pin enabled for channel scanning in the ADCSSL SFR is not scanned. Thus, the ADC converts one channel less than the number specified in the scan sequence. Note that this erratum does not affect devices that have a 10-bit 500 ksps ADC.

#### Work around

The user may enable an extra ("dummy") input pin in the channel-scanning sequence. For example, if it is desirable to scan pins AN3, AN4 and AN5 on the set of MUX A inputs while interleaving conversion from AN6 on the MUX B input, the user may configure the ADC as follows:

- ADCON2 = 0x041D
- ADCHS = 0x0600
- ADCSSL = 0x8038

For the configuration above, AN15 is the dummy input that will not be scanned. On the A/D interrupt, the A/D buffer will contain conversions from the following pins in sequence:

- ADCBUF0 = AN3
- ADCBUF1 = AN6
- ADCBUF2 = AN4
- ADCBUF3 = AN6
- ADCBUF4 = AN5
- ADCBUF5 = AN6
- ADCBUF6 = AN3
- ADCBUF7 = AN6

А3	B1	B2			
Χ	Χ	Χ			

#### 15. Module: DCI

The Data Converter Interface (DCI) module does not function correctly in Slave mode when the following conditions are true:

- The DCI module is configured to transmit/receive one serial clock (bit clock) after the frame synchronization pulse, DJST (DCICON1<5>) = 0.
- The frame length chosen is longer than 1 word, COFSG<3:0> (DCICON2<8:5>) > '0000'.

# Work around

The following work around may be applied to enable DCI communication in Slave mode when it is configured to transmit one serial clock after the frame synchronization pulse is received in a multi-word frame:

- 1. Set the DJST bit to '1'.
- Enable an additional time slot immediately following each time slot intended for communication.
- Enable an additional transmit/receive buffer word (modify COFSG bits) or an additional bit per word (modify WS) for each time slot intended for communication.
- 4. Shift the data word by 1-bit to the right and load the transmit buffer word(s), such that the Least Significant bit of the original data word to be transmitted is loaded into the additionally enabled bit of the Transmit Buffer register, TXBUFn, or the Most Significant bit (MSb) of the additionally enabled transmit buffer, TXBUFn + 1.

This work around is now demonstrated by an example.

Assume, the application needs the DCI module to act as a Slave transmitting 1 serial clock after the frame synchronization pulse is received. Further, assume that the application needs to transmit 16-bit data word on Time Slot 0 and the communication is over a 256\*Fs channel. In order to reduce interrupt frequency, we enable all 4 transmit buffers. The DCI module SFRs should be initialized as follows before being enabled:

 DCICON1 = 0x0720, DCICON2 = 0x0DEF DCICON3 = 0x0000, TSCON = RSCON = 0x0003

An example of loading the DCI transmit buffers for the configuration above is shown in Example 11. A timing diagram in Figure 1 illustrates the various signals for this example. A similar rule may be applied to reading the received data from the RXBUFn SFRs.

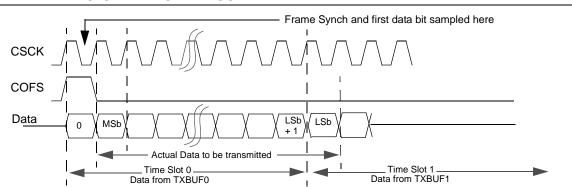
# **Affected Silicon Revisions**

А3	B1	B2			
Χ	Х	Х			

# **EXAMPLE 11: DCI SLAVE WORK AROUND**

BCLR	SR, #C
MOV	My1stTxDataWord, W0
RRC	WO, WO
RRC	W1, W1
MOV	WO, TXBUFO
MOV	W1, TXBUF1
MOV	My2ndTxDataWord, W0
RRC	WO, WO
RRC	W1, W1
MOV	W0, TXBUF2
MOV	W1, TXBUF3

#### FIGURE 1: DCI SLAVE WORK AROUND



- Note 1: The Slave mode operation shown in this figure uses the DCI module's operation with DJST = 1, to create a work around for the erratum associated with the DCI module when DJST = 0.
  - 2: Note that the actual data intended for transmission on Time Slot 0 is now straddled across two time slots Time Slot 0 and Time Slot 1. The MSb of Time Slot 0 is '0'; while the MSb of Time Slot 1 is actually the LSb of the data intended for transmission.
  - 3: Data loaded into TXBUF0 contains 15 MSbs of the actual 16-bit data to be transmitted, while the MSb of TXBUF0 is cleared.
  - 4: Not all serial clock pulses are shown in this timing diagram.

#### 16. Module: DCI

For this release of silicon, the DCI module should not be stopped when the device enters Idle mode.

#### Work around

Do not set the DCISIDL bit (DCICON1<13>). This will ensure the DCI module continues to run when the device enters Idle mode.

# **Affected Silicon Revisions**

	А3	B1	B2			
I	Χ	Χ	Χ			

#### 17. Module: CAN

Data read from the CAN module Special Function Registers may not be correct at device operation greater than 20 MIPS for VDD in the range 4.75V to 5.5V (or 10 MIPS for VDD in the range 3V to 3.6V).

If the dsPIC DSC device needs to operate at a throughput higher than 20 MIPS, the user should incorporate the suggested work arounds while reading CAN SFRs.

Applications that use Microchip's dsPIC30F Peripheral Library and Vector Informatik's CANbedded software, should operate the device at 20 MIPS or less.

#### Work arounds

# Work around 1: For Assembly Language Source Code

When reading any CAN SFR, perform two consecutive read operations of that SFR. The work around is demonstrated in Example 12. In this example, a Memory-Direct Addressing mode is used to read the SFR. The application may use any addressing mode to perform the read operation. Note that interrupts must be disabled so that the two consecutive reads do not get interrupted.

#### **EXAMPLE 12: CONSECUTIVE READS**

.include "p30f6014.inc"							
disi	#1						
mov	ClRXF0SIDL, w0 ; first SFR read						
mov	C1RXF0SIDL, w0 ; second SFR read						

#### Work around 2: For C Language Source Code

For C programmers, the MPLAB C30 v1.20.02 toolsuite provides a built-in function that may be incorporated in the application source code. This function may be used to read any CAN module SFRs. Some examples of usage are shown in the "readme.txt" file provided with the MPLAB C30 v1.20.02 toolsuite. The function has the following prototype:

unsigned \_\_builtin\_readsfr(volatile void \*);

The function argument is the address of a 16-bit SFR. This function should only be used to read the CAN Special Function Registers.

# Affected Silicon Revisions

А3	B1	B2			
Χ	Х	Х			

# 18. Module: Flash Memory

This release of silicon draws a current (IDD) of approximately 370 mA during any Row Erase operation performed on program Flash memory.

# Work arounds

#### Work around 1:

Supply the VDD pin using a voltage regulator capable of sourcing a minimum of 300 mA of current.

#### Work around 2:

When using a voltage regulator capable of driving 150 mA current and if Brown-out Reset (BOR) is enabled for a VDD greater than or equal to 4.2V, then connect a 1000  $\mu F$  Electrolytic capacitor across the VDD pin and ground.

If the Row Erase operation is performed as part of a RTSP operation, the user should ensure that the device is operating at less than 10 MIPS prior to the erase operation. To ensure that the device is operating at less than 10 MIPS, the application may post-scale the system clock or switch to the internal FRC oscillator.

А3	B1	B2			
Χ	Χ	Χ			

#### 19. Module: CPU

Applications operating off 5 volts VDD at 30 MIPS should ensure the VDD remains between 4.75V and 5.5V. For 5V applications, Table 4 summarizes the maximum MIPS that can be achieved across various temperatures.

# Work around

For 5 volt applications, use a voltage regulator that ensures VDD is in the range 4.75V to 5.5V, in order to achieve 30 MIPS operation.

# **Affected Silicon Revisions**

А3	B1	B2			
Χ	Х	Х			

# TABLE 4: OPERATING MIPS VS. VOLTAGE

VDD Range	Temp Range	Max MIPS				
(in volts)	(in °C)	dsPIC30FXXX-30I	dsPIC30FXXX-20I	dsPIC30FXXX-20E		
4.75 to 5.5	-40 to +85	30	20	_		
4.75 to 5.5	-40 to +125	_	_	20		

**Note:** Applications that use the CAN peripherals and data EEPROM should also refer to module 1. (Data EEPROM) and module 17. (CAN).

# 20. Module: Flash Memory

Addresses in the range, 0x6000 through 0xFFFF, may not be code-protected for this revision of dsPIC30F6011 and dsPIC30F6013 silicon.

#### Work around

None.

# **Affected Silicon Revisions**

А3	B1	B2			
Χ	Χ	Χ			

#### 21. Module: PLL

When the 4x PLL mode of operation is selected, the specified input frequency range of 4 MHz-10 MHz is not fully supported.

When device VDD is 2.5V-3.0V, the 4x PLL input frequency must be in the range of 4 MHz-5 MHz. When device VDD is 3.0V-3.6V, the 4x PLL input frequency must be in the range of 4 MHz-6 MHz for both industrial and extended temperature ranges.

#### Work around

- Use 8x PLL or 16x PLL mode of operation and set final device clock speed using the POST<1:0> oscillator postscaler control bits (OSCCON<7:6>).
- 2. Use the EC without PLL Clock mode with a suitable clock frequency to obtain the equivalent 4x PLL clock rate.

А3	B1	B2			
Χ	Х	Х			

# 22. Module: Interrupt Controller

The following sequence of events will lead to an address error trap. The generic term "Interrupt 1" is used to represent any enabled dsPIC30F interrupt.

- User software performs one of the following operations:
  - CPU IPL is raised to Interrupt 1 IPL level or higher, or
  - Interrupt 1 IPL is lowered to CPU IPL level or lower, or
  - Interrupt 1 is disabled (Interrupt 1 IE bit set to '0'), or
  - Interrupt 1 flag is cleared
- 2. Interrupt 1 occurs between 2 and 4 instruction cycles after any of the operations listed above.

#### Work arounds

# Work around 1: For Assembly Language Source Code

The user may disable interrupt nesting, disable interrupts before modifying the Interrupt 1 setting or execute a DISI instruction before modifying the CPU IPL or Interrupt 1. A minimum DISI value of 4 is required if the DISI instruction is executed immediately before the CPU IPL or Interrupt 1 is modified, as shown in Example 13. It is necessary to have DISI active for four cycles after the CPU IPL or Interrupt 1 is modified.

#### **EXAMPLE 13: USING DISI**

```
.include "p30fxxxx.inc"
...

DISI #4 ; protect the disable
; of INT1

BCLR IEC1, #INT1IE ; disable interrupt 1
... ; next instruction
;protected by DISI
```

# Work around 2: For C Language Source Code

For applications using the C language, MPLAB C30 versions 1.32 and higher provide several macros for modifying the CPU IPL. The SET\_CPU\_IPL macro provides the ability to safely modify the CPU IPL, as shown in Example 14.

# EXAMPLE 14: USING SET\_CPU\_IPL MACRO

```
// Note: Macro defined in device include
// files
#define SET_CPU_IPL (ipl){ \
int DISI_save; \
\
DISI_save = DISICNT; \
asm volatile ("disi #0x3FFF");\
SRbits.IPL = ipl; \

DISICNT = DISI_save; } (void) 0;
__builtin_nop(); \
__builtin_nop(); \
#include "p30fxxxx.h"
. . .
SET_CPU_IPL (3)
. . .
```

There is one level of DISI, so this macro saves and restores the DISI state. For temporarily modifying and restoring the CPU IPL, the macros SET\_AND\_SAVE\_CPU\_IPL and RESTORE\_CPU\_IPL can be used, as shown in Example 15. These macros also make use of the SET\_CPU\_IPL macro.

# EXAMPLE 15: USING SET\_AND\_SAVE\_CPU\_IPL AND RESTORE\_CPU\_IPL MACROS

```
// Note: Macros defined in device include files
#define SET_AND_SAVE_CPU_IPL (save_to, ipl){ \
    save_to = SRbits.IPL; \
    SET_CPU_IPL (ipl); } (void) 0;

#define RESTORE_CPU_IPL (saved_to) SET_CPU_IPL (saved_to)

#include "p30fxxxx.h"
. . .
int save_to;
SET_AND_SAVE_CPU_IPL (save_to, 3)
. . . .
RESTORE_CPU_IPL (save_to)
```

For modification of the Interrupt 1 setting, the INTERRUPT\_PROTECT macro can be used. This macro disables interrupts before executing the desired expression, as shown in Example 16. This macro is not distributed with the compiler.

# EXAMPLE 16: USING INTERRUPT\_PROTECT MACRO

```
#define INTERRUPT_PROTECT (x) {
int save_sr; \
SET_AND_SAVE_CPU_IPL (save_sr, 7);\
x; \
RESTORE_CPU_IPL (save_sr); } (void) 0;
. . .
INTERRUPT_PROTECT (IECObits.UlTXIE=0);
```

**Note:** If you are using a MPLAB C30 compiler version earlier than version 1.32, you may still use the macros by adding them to your application.

# **Affected Silicon Revisions**

А3	B1	B2			
Χ	Х	Χ			

# 23. Module: PLL

If 8x PLL mode is used, the input frequency range is 5 MHz-10 MHz instead of 4 MHz-10 MHz.

#### Work around

None. If 8x PLL is used, ensure that the input crystal or clock frequency is 5 MHz or greater.

А3	B1	B2			
Х	Χ	Х			

# 24. Module: Sleep Mode

Execution of the Sleep instruction (PWRSAV #0) may cause incorrect program operation after the device wakes up from Sleep. The current consumption during Sleep may also increase beyond the specifications listed in the device data sheet.

# Work arounds

To avoid this issue, implement any of the following three work arounds, depending on the application requirements.

#### Work around 1:

Ensure that the PWRSAV #0 instruction is located at the end of the last row of program Flash memory available on the target device and fill the remainder of the row with NOP instructions.

This can be accomplished by replacing all occurrences of the PWRSAV #0 instruction with a function call to a suitably aligned subroutine. The address() attribute provided by the MPLAB ASM30 assembler can be utilized to correctly align the instructions in the subroutine. For an application written in C, the function call would be GotoSleep(), while for an assembly language application, the function call would be CALL \_GotoSleep.

The address error trap service routine software can then replace the invalid return address saved on the stack with the address of the instruction immediately following the \_GotoSleep or GotoSleep() function call. This ensures that the device continues executing the correct code sequence after waking up from Sleep mode.

Example 17 demonstrates the work around described above.

#### **EXAMPLE 17:**

```
______
.global __reset
.global _main
.global _GotoSleep
.global __AddressError
.global __INT1Interrupt
   .section *, code
main:
  BSET
         INTCON2, #INT1EP ; Set up INT pins to detect falling edge
   BCLR IFS1, #INT1IF ; Clear interrupt pin interrupt flag bits
  BSET IEC1, #INT1IE ; Enable ISR processing for INT pins
        _GotoSleep
                        ; Call function to enter SLEEP mode
  CALL
_continue:
  BRA continue
; Address Error Trap
 AddressError:
  BCLR
        INTCON1, #ADDRERR
   ; Set program memory return address to _continue
   POP.D WO
  MOV.B #tblpage (_continue), W1
  MOV
         #tbloffset (_continue), W0
   PUSH.D W0
   RETFIE
 INTlInterrupt:
                           ; Ensure flag is reset
  BCLR IFS1, #INT1IF
  RETELE
                             ; Return from Interrupt Service Routine
   .section *, code, address (0x1FC0)
; fill remainder of the last row with NOP instructions
   .rept 31
      NOP
   .endr
; Place SLEEP instruction in the last word of program memory
  PWRSAV #0
```

#### Work around 2:

Instead of executing a PWRSAV #0 instruction to put the device into Sleep mode, perform a clock switch to the 512 kHz Low-Power RC (LPRC) Oscillator with a 64:1 postscaler mode. This enables the device to operate at 0.002 MIPS, thereby significantly reducing the current consumption of the device. Similarly, instead of using an interrupt to wake-up the device from Sleep mode, perform another clock switch back to the original oscillator source to resume normal operation. Depending on the device, refer to Section 7. "Oscillator" (DS70054) or Section 29. "Oscillator" (DS70268) in the "dsPIC30F Family Reference Manual" (DS70046) for more details on performing a clock switch operation.

**Note:** The above work around is recommended for users for whom application hardware changes are not possible.

#### Work around 3:

Instead of executing a PWRSAV #0 instruction to put the device into Sleep mode, perform a clock switch to the 32 kHz Low-Power (LP) Oscillator with a 64:1 postscaler mode. This enables the device to operate at 0.000125 MIPS, thereby significantly reducing the current consumption of the device. Similarly, instead of using an interrupt to wake-up the device from Sleep mode, perform another clock switch back to the original oscillator source to resume normal operation. Depending on the device, refer to Section 7. "Oscillator" or Section 29. "Oscillator" (DS70054) (DS70268) in the "dsPIC30F Family Reference Manual' (DS70046) for more details on performing a clock switch operation.

Note: The above work around is recommended for users for whom application hardware changes are possible, and also for users whose application hardware already includes a 32 kHz LP Oscillator crystal.

А3	B1	B2			
X	Χ	Χ			

# 25. Module: I<sup>2</sup>C

When the  $I^2C$  module is configured as a slave, either in single-master or multi-master mode, the  $I^2C$  receiver buffer is filled whether a valid slave address is detected or not. Therefore, an  $I^2C$  receiver overflow condition occurs and this condition is indicated by the I2COV flag in the I2CSTAT register.

This overflow condition inhibits the ability to set the  $I^2C$  receive interrupt flag (SI2CF) when the last valid data byte is received. Therefore, the  $I^2C$  slave Interrupt Service Routine is not called and the  $I^2C$  receiver buffer is not read prior receiving the next data byte.

# **Work arounds**

To avoid this issue, either of the following two work arounds can be implemented, depending on the application requirements.

#### Work around 1:

For applications in which the I<sup>2</sup>C receiver interrupt is not required, the following procedure can be used to receive valid data bytes:

- 1. Wait until the RBF flag is set.
- 2. Poll the I<sup>2</sup>C receiver interrupt SI2CIF flag.
- 3. If SI2CF is not set in the corresponding Interrupt Flag Status register (IFSx), a valid address or data byte has not been received for the current slave. Execute a dummy read of the I<sup>2</sup>C receiver buffer, I2CRCV; this will clear the RBF flag. Go back to step 1 until SI2CF is set and then continue to Step 4.
- If the SI2CF is set in the corresponding Interrupt Flag Status register (IFSx), valid data has been received. Check the D\_A flag to verify that an address or a data byte has been received.
- Read the I2CRCV buffer to recover valid data bytes. This will also clear the RBF flag.
- 6. Clear the I<sup>2</sup>C receiver interrupt flag SI2CF.
- 7. Go back to step 1 to continue receiving incoming data bytes.

#### Work around 2:

Use this work around for applications in which the I<sup>2</sup>C receiver interrupt is required. Assuming that the RBF and the I2COV flags in the I2CSTAT register are set due to previous data transfers in the I<sup>2</sup>C bus (i.e., between master and other slaves); the following procedure can be used to receive valid data bytes:

- When a valid slave address byte is detected, SI2CF bit is set and the I<sup>2</sup>C slave interrupt service routine is called; however, the RBF and I2COV bits are already set due to data transfers between other I<sup>2</sup>C nodes.
- 2. Check the status of the D\_A flag and the I2COV flag in the I2CSTAT register when executing the I<sup>2</sup>C slave service routine.
- 3. If the D\_A flag is cleared and the I2COV flag are set, an invalid data byte was received but a valid address byte was received. The overflow condition occurred because the I<sup>2</sup>C receive buffer was overflowing with previous I<sup>2</sup>C data transfers between other I<sup>2</sup>C nodes. This condition only occurs after a valid slave address was detected.
- 4. Clear the I2COV flag and perform a dummy read of the I<sup>2</sup>C receiver buffer, I2CRCV, to clear the RBF bit and recover the valid address byte. This action will also avoid the loss of the next data byte due to an overflow condition.
- Verify that the recovered address byte matches the current slave address byte. If they match, the next data to be received is a valid data byte.
- 6. If the D\_A flag and the I2COV flag are both set, a valid data byte was received and a previous valid data byte was lost. It will be necessary to code for handling this overflow condition.

А3	B1	B2			
Χ	Х	Х			

#### 26. Module: I/O

If the user application enables the auto-baud feature in the UART module, the I/O pin multiplexed with the IC1 (Input Capture) pin cannot be used as a digital input. However, the external interrupt function (INT1) can be used.

# Work around

None.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ	Х	Χ			

# 27. Module: I<sup>2</sup>C

If there are two I<sup>2</sup>C devices on the bus, one of them is acting as the Master receiver and the other as the Slave transmitter. If both devices are configured for 10-bit addressing mode, and have the same value in the A10 and A9 bits of their addresses, then when the Slave select address is sent from the Master, both the Master and Slave acknowledge it. When the Master sends out the read operation, both the Master and the Slave enter into Read mode and both of them transmit the data. The resultant data will be the ANDing of the two transmissions.

# Work around

In all I<sup>2</sup>C devices, the addresses as well as bits A10 and A9 should be different.

#### **Affected Silicon Revisions**

	А3	B1	B2			
Ī	Χ	Χ	Χ			

# 28. Module: Timer

When the timer is being operated in Asynchronous mode using the secondary oscillator (32.768 kHz) and the device is put into Sleep mode, a clock switch to any other oscillator mode before putting the device to Sleep prevents the timer from waking the device from Sleep.

# Work around

Do not clock switch to any other oscillator mode if the timer is being used in Asynchronous mode using the secondary oscillator (32.768 kHz).

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ	Χ	Χ			

#### 29. Module: PLL

The PLL LOCK Status bit (OSCCON<5>) can occasionally get cleared and generate an oscillator failure trap even when the PLL is still locked and functioning correctly.

# Work around

The user application must include an oscillator failure trap service routine. In the trap service routine, first inspect the status of the Clock Failure Status bit (OSCCON<3>). If this bit is clear, return from the trap service routine immediately and continue program execution.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ	Χ	Χ			

# 30. Module: PSV Operations

An address error trap occurs in certain addressing modes when accessing the first four bytes of an PSV page. This only occurs when using the following addressing modes:

- MOV.D
- Register Indirect Addressing (word or byte mode) with pre/post-decrement

#### Work around

Do not perform PSV accesses to any of the first four bytes using the above addressing modes. For applications using the C language, MPLAB C30 version 3.11 or higher, provides the following command-line switch that implements a work around for the erratum.

-merrata=psv\_trap

Refer to the readme.txt file in the MPLAB C30 v3.11 tool suite for further details.

А3	B1	B2			
Χ	Χ	Χ			

# 31. Module: I<sup>2</sup>C

In 10-bit Addressing mode, some address matches don't set the RBF flag or load the receive register I2CxRCV, if the lower address byte matches the reserved addresses. In particular, these include all addresses with the form XX0000XXXX and XX1111XXXX, with the following exceptions:

- 001111000X
- 011111001X
- 101111010X
- 111111011X

# Work around

Ensure that the lower address byte in 10-bit Addressing mode does not match any 7-bit reserved addresses.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ	Χ	Χ			

# 32. Module: I<sup>2</sup>C

When the  $I^2C$  module is configured as a 10-bit slave with and address of 0x102, the I2CxRCV register content for the lower address byte is 0x01 rather than 0x02; however, the module acknowledges both address bytes.

# Work around

None.

# **Affected Silicon Revisions**

А3	B1	B2			
Х	Х	Х			

# 33. Module: I<sup>2</sup>C

When the I<sup>2</sup>C module is enabled by setting the I2CEN bit in the I2CCON register, the dsPIC DSC device generates a glitch on the SDA and SCL pins. This glitch falsely indicates "Communication Start" to all devices on the I<sup>2</sup>C bus, and can cause a bus collision in a multi-master configuration.

Additionally, when the I2CEN bit is set, the S and P bits of the I<sup>2</sup>C module are set to values '1' and '0', respectively, which indicate a "Communication Start" condition.

#### Work arounds

To avoid this issue, either of the following two work arounds can be implemented, depending on the application requirements.

#### Work around 1:

In a single-master environment, add a delay between enabling the I<sup>2</sup>C module and the first data transmission. The delay should be equal to or greater than the time it takes to transmit two data bits.

In the multi-master configuration, in addition to the delay, all other I<sup>2</sup>C masters should be synchronized and wait for the I<sup>2</sup>C module to be initialized before initiating any kind of communication.

#### Work around 2:

In dsPIC DSC devices in which the I<sup>2</sup>C module is multiplexed with other modules that have precedence in the use of the pin, it is possible to avoid this glitch by enabling the higher priority module before enabling the I<sup>2</sup>C module.

Use the following procedure to implement this work around:

- Enable the higher priority peripheral module that is multiplexed on the same pins as the I<sup>2</sup>C module.
- 2. Set up and enable the I<sup>2</sup>C module.

Disable the higher priority peripheral module that was enabled in step 1.

Note: Work around 2 works only for devices that share the SDA and SCL pins with another peripheral that has a higher precedence over the port latch, such as the UART. The priority is shown in the pin diagram located in the data sheet. For example, if the SDA and SCL pins are shared with the UART and SPI pins, and the UART has higher precedence on the port latch pin.

А3	B1	B2			
Χ	Х	Х			

#### 34. Module: CAN

CAN Receive filters 3, 4 and 5 may not work for a given combination of instruction cycle speed and CAN bit time quanta.

#### Work around

Do not use CAN RX filters 3, 4 and 5. Instead, use filters 0, 1 and 2.

# **Affected Silicon Revisions**

А3	B1	B2			
Х	Χ	Х			

# 35. Module: Interrupt Controller

A specific write sequence for Interrupt Priority Control 2 (IPC2) SFR is required to prevent possible data corruption in the Interrupt Enable Control 2 (IEC2) SFR. Interrupts must be disabled during this IPC2 SFR write sequence.

#### Work around

An example of this write sequence is shown in Example 18.

#### **EXAMPLE 18:**

mov	#IPC2, w0	;Point w0 to IPC2
mov	#0x4444, w1	;Write data to go to IPC2
disi	#2	;Disable interrupts for
		inext two cycles
mov	w1, IPC2	;Write the data to IPC2
mov	#IPC2, w0	;Target w1 to keep IPC2
		address on bus

When coding in C, the write sequence shown above can be implemented using inline assembly instructions. The equivalent write sequence using the C30 compiler is shown in Example 19.

# **EXAMPLE 19:**

#### Affected Silicon Revisions

А3	B1	B2			
Χ	Χ				

#### 36. Module: Program Memory

For this revision of silicon, run-time self-programming operations should not be performed on the User Program Memory and Configuration Fuse bits. Configuration Fuse bits may be programmed within the MPLAB IDE using a device programmer, for example, MPLAB ICD 2.

Note that the on-chip Data EEPROM can be self-programmed at run-time.

#### Work around

None.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ					

#### 37. Module: ADC

Sampling multiple channels sequentially using any conversion trigger source other than the auto-convert feature requires SAMC bits to be non-zero. Thus, if the following conditions are all satisfied, the module may not operate as specified:

Multiple S/H channels are sampled sequentially

CHPS (ADCON2<9:8>) is not equal to '00' and SIMSAM (ADCON1<3>) = 0

 Auto-convert option is not chosen as the conversion trigger

SSRC (ADCON1<7:5>) is not equal to '111'

- SAMC (ADCON3<12:8>) is equal to '00000'

# Work around

Set the value of the SAMC bits to anything other than '00000'. The module will now operate as specified.

А3	В1	B2			
Χ					

#### 38. Module: QEI

For this release of silicon, the Quadrature Encoder Interface (QEI) module should not be operated in the Reset on Index Pulse mode.

# Work around

None.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ					

#### 39. Module: PWM

The input clock to the PWM time base has prescaler options of 1:1, 1:4, 1:16 or 1:64, selected by the PTCKPS (PTCON<3:2>) control bits. In this release of silicon, the options 1:4, 1:16 and 1:64 may produce unexpected results when used to generate center-aligned PWM pulses.

#### Work around

The prescaler should be set to the 1:1 option (i.e., prescaler should be disabled) in this release of silicon when generating center-aligned PWM pulses.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ					

#### 40. Module: PWM

The output override function of the PWM module, controlled by the OVDCON register and the OSYNC bit (PWMCON2<1>), produces unexpected results on the output pins in certain cases when the module is used in Complementary mode. These cases are shown in Table 5. Future releases of silicon will operate as shown in the "Expected Output" columns in Table 5.

#### Work around

None.

#### **Affected Silicon Revisions**

А3	B1	B2			
Χ					

# TABLE 5: OUTPUT OVERRIDE: EXPECTED VS. OBSERVED OPERATION(1,2,3)

OVDCON	Dead Time	Expecte	d Output	Observe	d Output	Comments
OVDCON	Enabled	PWM1H PWM1L PWM1H PWM1L		Comments		
0x0100	Yes	Low	PWM	Low	Low	Output on PWM1L pin is shortened by dead time
0x0200	Yes	PWM	Low	Low	Low	Output on PWM1H pin is shortened by dead time

- Note 1: Other Motor Control PWM SFRs were initialized as follows: PTCON = 0x8002 and PWMCON1 = 0x0011.
  - 2: For these settings of OVDCON, the OSYNC bit (PWMCON<1>) should be cleared to '0' for correct operation.
  - 3: Results are shown here for the PWM1H and PWM1L pins only. Similar results will be observed for any other pair of complementary output pins (PWM2H/L, PWM3H/L and PWM4H/L) and any other chosen duty cycle.

#### 41. Module: CPU

The device exhibits IPD of approximately 100  $\mu$ A.

# Work around

If the application does not use the on-chip A/D converter, it is possible to reduce the IPD to values below 0.1  $\mu$ A. The following additional measures need to be taken in these circumstances:

- In the application hardware, the VREF+/RA10 pin (pin 24) on the dsPIC30F601X device should be connected to the circuit ground (GND).
- In the application software, the code sequence shown in Example 20 should be executed to bring the device into the power-saving Sleep mode.

#### **EXAMPLE 20:**

```
.include "p30f6014.inc"
......

BCLR ADCON1, #ADON ;Required code
MOV #0x2000, W0 ;sequence for
MOV W0, ADCON2 ;low power-down
BCLR PMD1, #ADCMD ;current.
PWRSAV #SLEEP_MODE ;Device enters
;SLEEP mode here
```

# **Affected Silicon Revisions**

А3	B1	B2			
Χ					

# 42. Module: ADC

If the ADC module is in an enabled state when the device enters Sleep mode as a result of executing a PWRSAV #0 instruction, the device power-down current (IPD) may exceed the specifications listed in the device data sheet. This may happen even if the ADC module is disabled by clearing the ADON bit prior to entering Sleep mode.

# Work around

In order to remain within the IPD specifications listed in the device data sheet, the user software must completely disable the ADC module by setting the ADC Module Disable bit in the corresponding Peripheral Module Disable register (PMDx), prior to executing a PWRSAV #0 instruction.

А3	B1	B2			
Χ	Χ	Χ			

# **Data Sheet Clarifications**

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS70117**F**):

**Note:** Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

# 1. Module: DC Characteristics: I/O Pin Input Specifications

The maximum value for parameter DI19 (VIL specifications for SDAx and SCLx pins) and the minimum value for parameter DI29 (VIH specifications for SDAx and SCLx pins) were stated incorrectly in Table 23-8 of the current device data sheet. The correct values are shown in bold type in Table 6.

TABLE 6: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS

DC CHA	DC CHARACTERISTICS			Standard Operating Conditions: 3.3V and 5.0V (±10%)  (unless otherwise stated)  Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended					
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions		
	VIL	Input Low Voltage							
DI19		SDA, SCL	Vss	_	0.8	V	SMbus enabled		
	VIH	Input High Voltage							
DI29		SDA, SCL	2.1	_	VDD	V	SMbus enabled		

# APPENDIX A: REVISION HISTORY

#### Rev A Document (4/2009)

Initial release of this document; issued for revision A3, B1 and B2 silicon.

Includes silicon issues 1 (Data EEPROM), 2-4 (CPU), 5 (PSV Operations), 6 (CPU), 7 (Flash Memory), 8 (Data Memory), 9 (Interrupt Controller), 10-11 (CPU), 12 (Timers), 13 (Output Compare), 14 (ADC), 15-16 (DCI), 17 (CAN), 18 (Flash Memory), 19 (CPU), 20 (Flash Memory), 21 (PLL), 22 (Interrupt Controller), 23 (PLL), 24 (Sleep Mode), 25 (I<sup>2</sup>C), 26 (I/O), 27 (I<sup>2</sup>C), 28 (Timer), 29 (PLL), 30 (PSV Operations), 31-33 (I<sup>2</sup>C), 34 (CAN), 35 (Interrupt Controller), 36 (Program Memory), 37 (ADC), 38 (QEI), 39-40 (PWM) and 41 (CPU).

This document replaces the following errata documents:

- DS80176, "dsPIC30F6011/6012/6013/6014 Rev. A3 Silicon Errata"
- DS80183, "dsPIC30F6011/6012/6013/6014 Rev. B1 Silicon Errata"
- DS80198, "dsPIC30F6011/6012/6013/6014 Rev. B2 Silicon Errata"

# Rev B Document (7/2009)

Updated silicon issue 22 (Interrupt Controller).

Added Affected Revisions table to issue 41 (CPU).

# Rev C Document (2/2010)

Updated silicon issue 22 (Interrupt Controller).

# Rev D Document (6/2010)

Added silicon issue 42 (ADC) and data sheet clarification 1 (DC Characteristics: I/O Pin Input Specifications).

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